



Product/Process Change Notice - PCN 20_0158 Rev. -

Analog Devices, Inc. Three Technology Way Norwood, Massachusetts 02062-9106

This notice is to inform you of a change that will be made to certain ADI products (see Appendix A) that you may have purchased in the last 2 years. **Any inquiries or requests with this PCN (additional data or samples) must be sent to ADI within 30 days of publication date.** ADI contact information is listed below.

PCN Title: Change of Waffle Pack for AD8138A

Publication Date: 16-Mar-2020

Effectivity Date: 18-Jun-2020 *(the earliest date that a customer could expect to receive changed material)*

Revision Description:

Initial Release.

Description Of Change:

Change of waffle pack from H20-040055-24 to H20-044-30 for AD8138A.

Reason For Change:

Change waffle pack cavity dimension in order to improve process, quality, manufacturing productivity and reduce machine set-up time caused by current waffle pack with tight clearance and shallow depth.

Impact of the change (positive or negative) on fit, form, function & reliability:

No effect on fit, form, function and reliability.

Summary of Supporting Information:

No change in product and material. See supporting document provided with this PCN for comparison of grid.

Supporting Documents

Attachment 1: Type: Other

ADI_PCN_20_0158_Rev_-_Packing Change Comparison.pdf

For questions on this PCN, please send an email to the regional contacts below or contact your local ADI sales representatives.

Americas:
PCN_Americas@analog.com

Europe:
PCN_Europe@analog.com

Japan:
PCN_Japan@analog.com

Rest of Asia:
PCN_ROA@analog.com

Appendix A - Affected ADI Models

Added Parts On This Revision - Product Family / Model Number (1)

AD8138 / AD8138ACHIPS				
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Appendix B - Revision History

Rev	Publish Date	Effectivity Date	Rev Description
Rev. -	16-Mar-2020	18-Jun-2020	Initial Release.

Analog Devices, Inc.

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